



**PARA LIGHT ELECTRONICS CO., LTD.**  
4F, No.1, Lane 93, Chien Yi Road, Chung Ho City, Taipei, Taiwan.  
Tel: 886-2-2225-3733 Fax: 886-2-2225-4800  
E-mail: [para@para.com.tw](mailto:para@para.com.tw) <http://www.para.com.tw>

# DATA SHEET

PART NO.: L-C195JYJGCT

REV: A / 0

CUSTOMER'S APPROVAL: \_\_\_\_\_

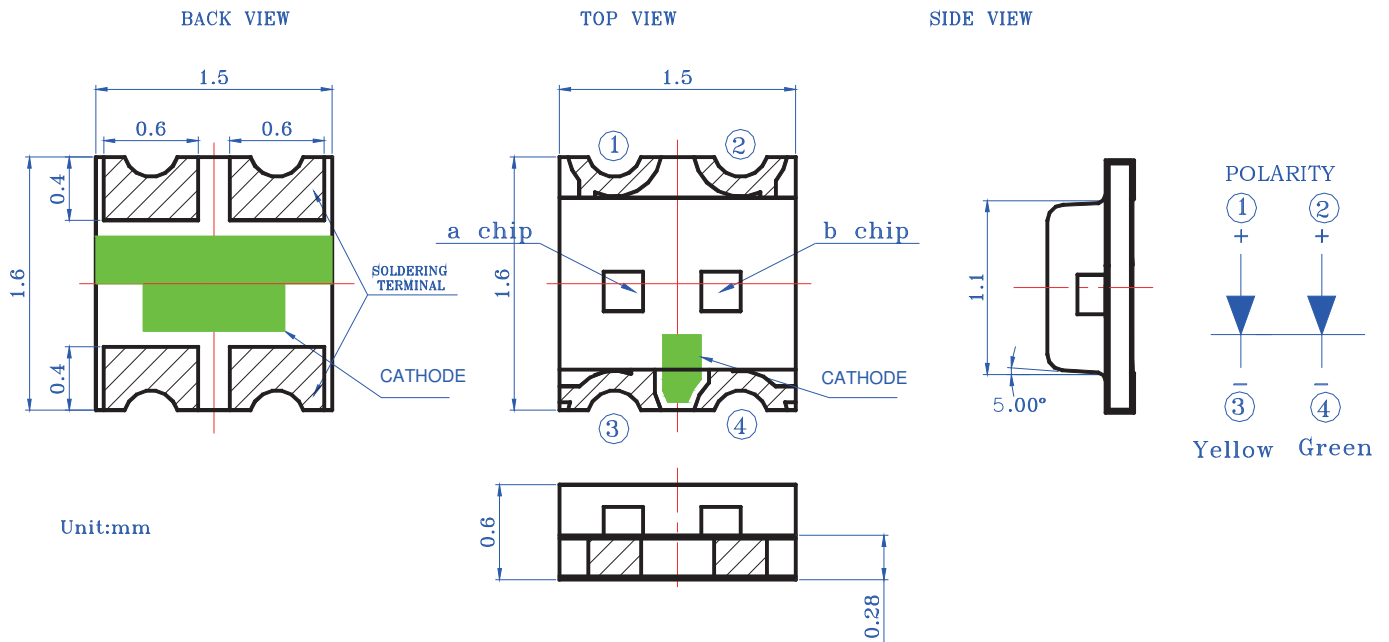
DCC: \_\_\_\_\_

DRAWING NO.: DS-78-14-0006

DATE: 2014-8-11

PAGE 1 of 14

● PACKAGE OUTLINE DIMENSIONS



Notes:

1. a chip: Yellow; b chip: Green
2. All dimensions are in millimeters.
3. Tolerance is  $\pm 0.1\text{mm}$  (.004") unless otherwise noted.

● Features

- \* Dual color, top view, wide view angle Chip LED.
- \* Package in 8mm tape on 7" diameter reels.
- \* Compatible with automatic Pick & Place equipment.
- \* Compatible with Reflow soldering and Wave soldering processes.
- \* EIA STD package.
- \* I.C. compatible.
- \* Pb free product.



# SURFACE MOUNT DEVICE LED

Part No.: L-C195JYJGCT

REV:A / 0

## ● Chip Materials

Chip	Light Color	Dice Material	Lens Color
a	JY: Yellow	AllnGap	Water Clear
b	JG: Green	AllnGap	

## ● Absolute Maximum Ratings (Ta=25°C)

Symbol	Parameter	Rating		Unit
		Green	Yellow	
PD	Power Dissipation	60	75	mW
IPF	Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	60	80	mA
IF	Continuous Forward Current	30	30	mA
-	De-rating Linear From 25°C	0.25	0.25	mA/°C
VR	Reverse Voltage	5	5	V
ESD	Electrostatic Discharge Threshold (HBM) <sup>Note A</sup>	2000	2000	
Topr	Operating Temperature Range	-40 ~ +85		°C
Tstg	Storage Temperature Range	-40 ~ +85		°C
-	Wave Soldering Condition (Two times Max.)	260 (for 5 seconds)		°C
-	Infrared Soldering Condition (Two times MAX.)	240 (for 10 seconds)		°C

Note A:

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

## ● Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Green	Yellow	Unit	Test Condition	
Luminous Intensity	Min.	11.2	28	mcd	IF=20mA	
	Typ.	18	35			
	Max.					
Viewing Angle	Typ.	2θ 1/2		deg	Note 2	
Peak Wavelength	Typ.	λ p	571	591	nm	Measurement @Peak
Dominant Wavelength	Typ.	λ d	570	590	nm	IF=20mA
Spectral Line Half-Width	Typ.	Δ λ	15	16	nm	
Forward Voltage	Typ.	VF	2.0	2.0	V	IF =20mA
	Max.		2.4	2.4		
Reverse Current	Max.	IR	10	10	μ A	VR = 5V

Notes:

1. Luminous intensity is measured with a light sensor and filter combination that proximates the CIE eye-response curve.
2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength  $\lambda_d$  is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
4. Caution in ESD:  
Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

● Typical Electro-Optical Characteristics Curves

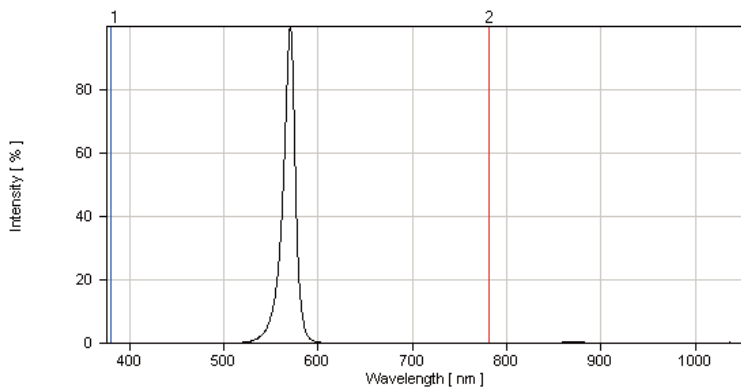


Fig.1 Green Relative Intensity vs. Wavelength

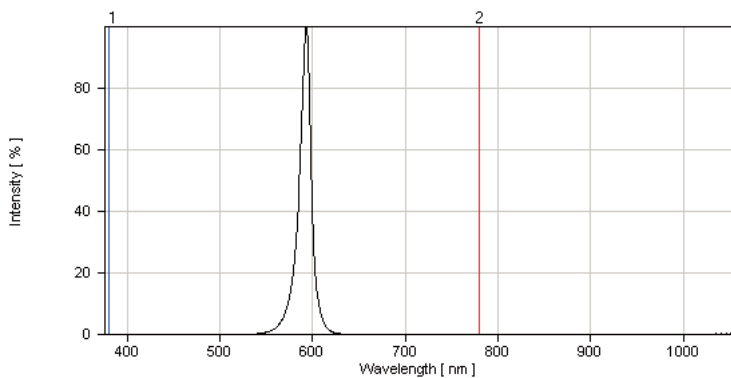


Fig.1 Yellow Relative Intensity vs. Wavelength

● Green Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

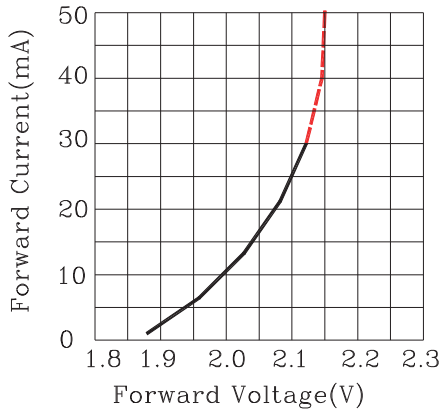


Fig.2 Forward Current vs. Forward Voltage

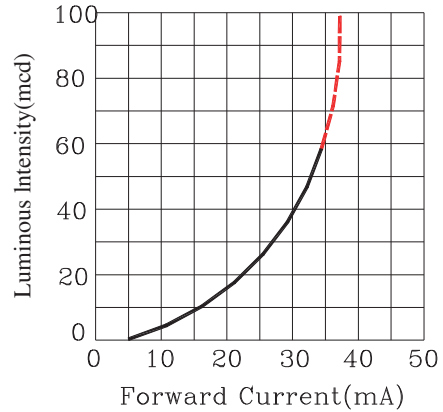


Fig.3 Luminous Intensity vs. Forward Current

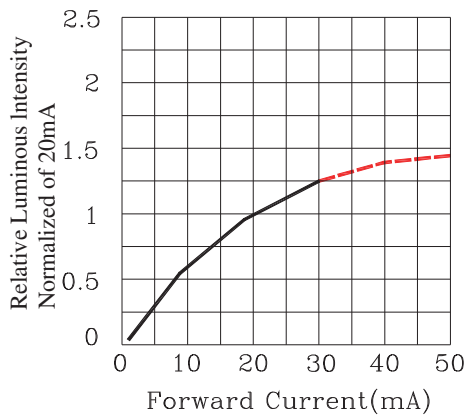


Fig.4 Relative Luminous Intensity vs. Forward Current

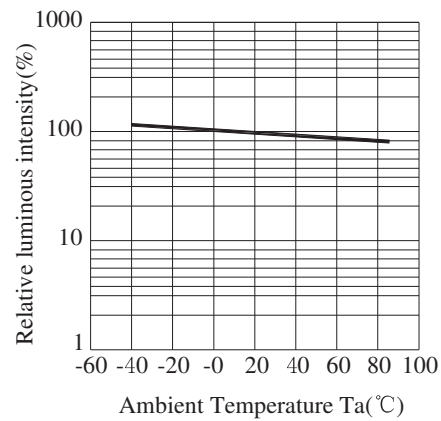


Fig.5 Luminous Intensity vs. Ambient Temperature

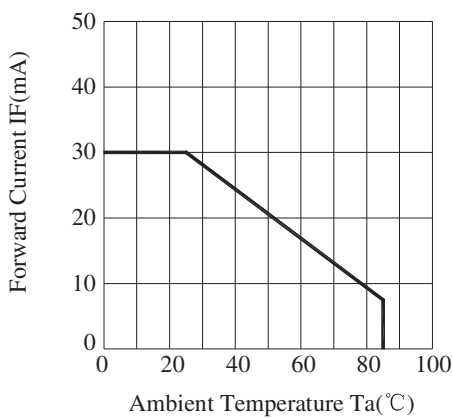


Fig.6 Forward Current Derating Curve

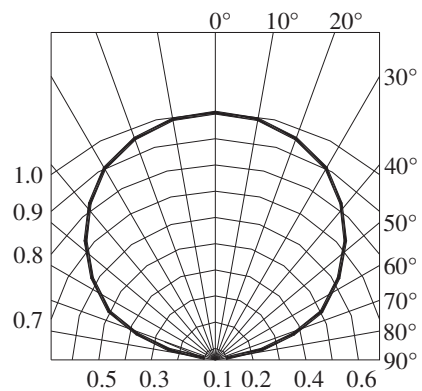


Fig.7 Relative Intensity vs. Angle

● Yellow Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

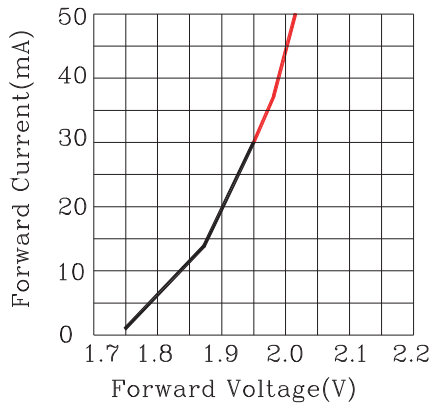


Fig.2 Forward Current vs. Forward Voltage

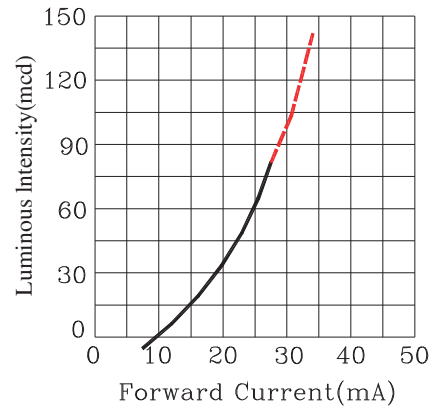


Fig.3 Luminous Intensity vs. Forward Current

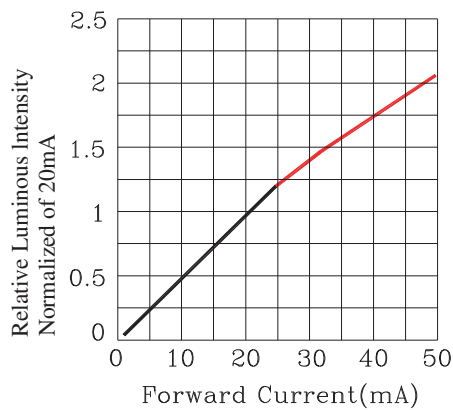


Fig.4 Relative Luminous Intensity vs. Forward Current

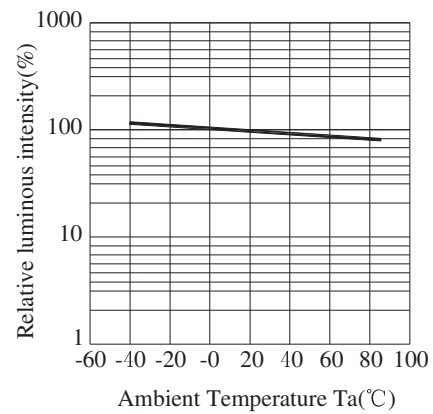


Fig.5 Luminous Intensity vs. Ambient Temperature

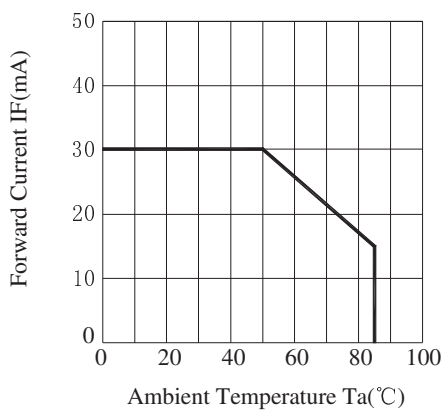


Fig.6 Forward Current Derating Curve

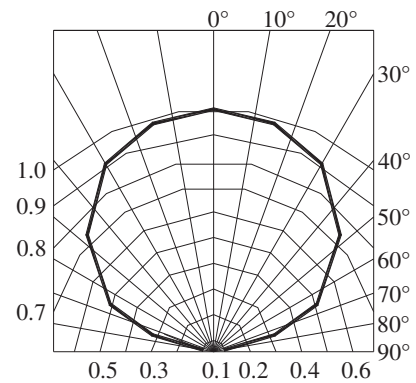


Fig.7 Relative Intensity vs. Angle

## ● Label Explanation



ITEM CODE:PARRA LIGHT

PART NO: L-C195JYJGCT

IV --- Luminous Intensity Code

LOT NO: EM S L 12 09 0110  
          A    B    C    D    E    F

A---EM: Emos Code

B---S:SMD

L---Local

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG :

3000pcs for 150、170、110、155、115 series

4000pcs for 191 series

5000pcs for 192 series

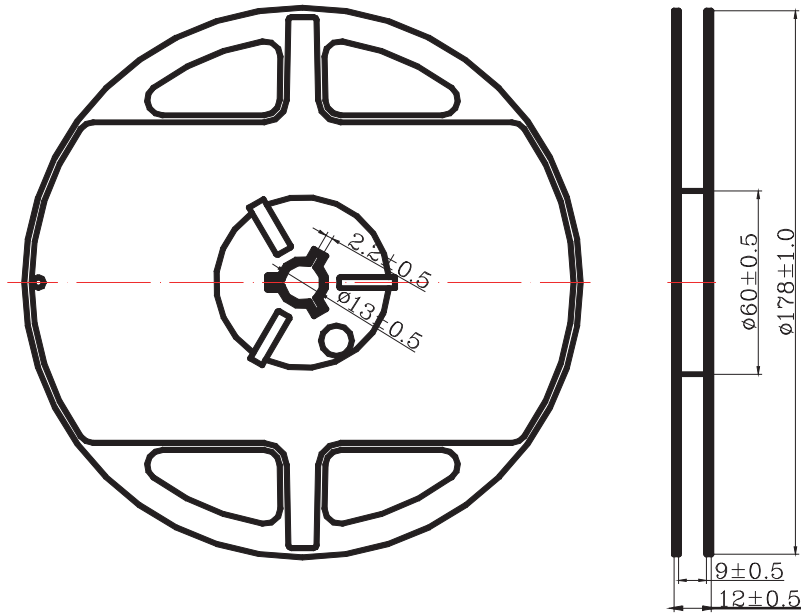
DATE CODE: 2012 09 10  
                  G    H    I

G--- Year

H--- Month

I --- Day

● Reel Dimensions

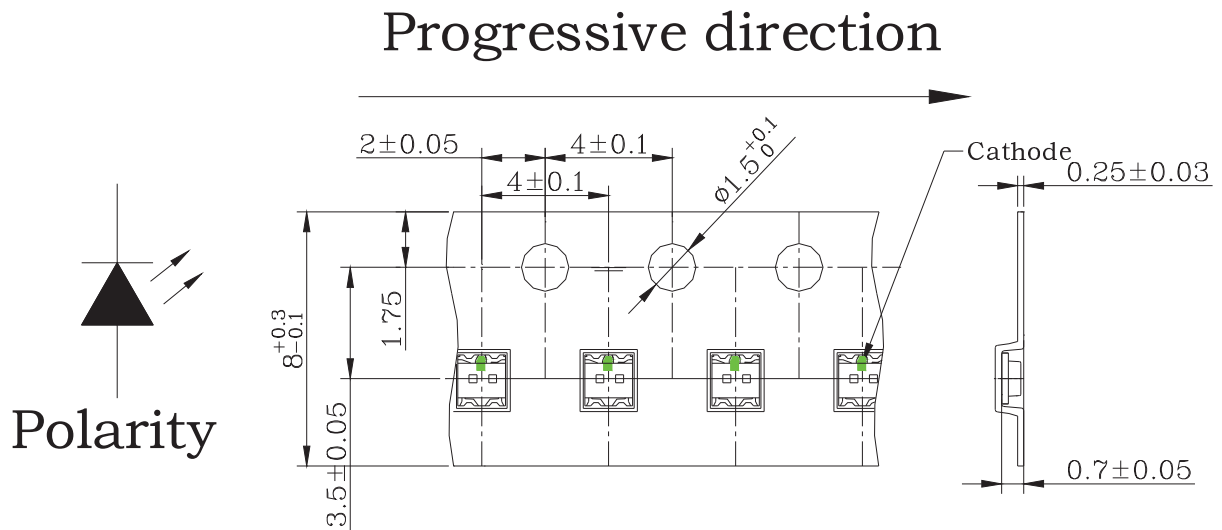


Notes:

1. Taping Quantity: 3000pcs
2. The tolerances unless mentioned is  $\pm 0.1\text{mm}$ , Angle  $\pm 0.5^\circ$  , Unit: mm.

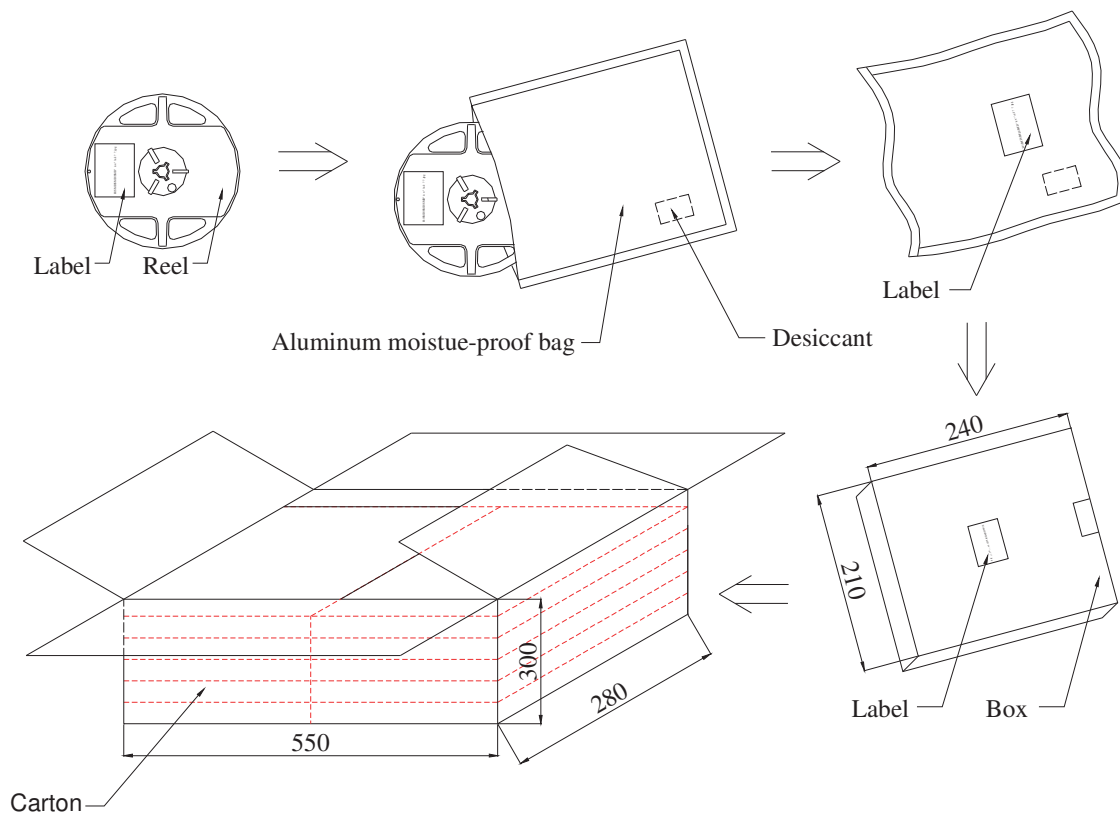


● Package Dimensions Of Tape And Reel



Notes: All dimensions are in millimeters.

Moisture Resistant Packaging

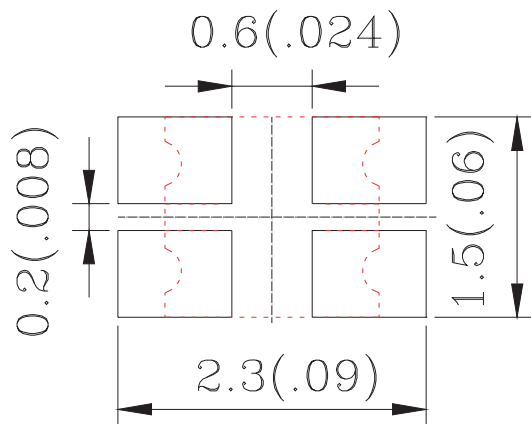


Notes : One reel in a bag, six bag in a inner box, six inner boxes in a carton. Unit : mm

● Cleaning

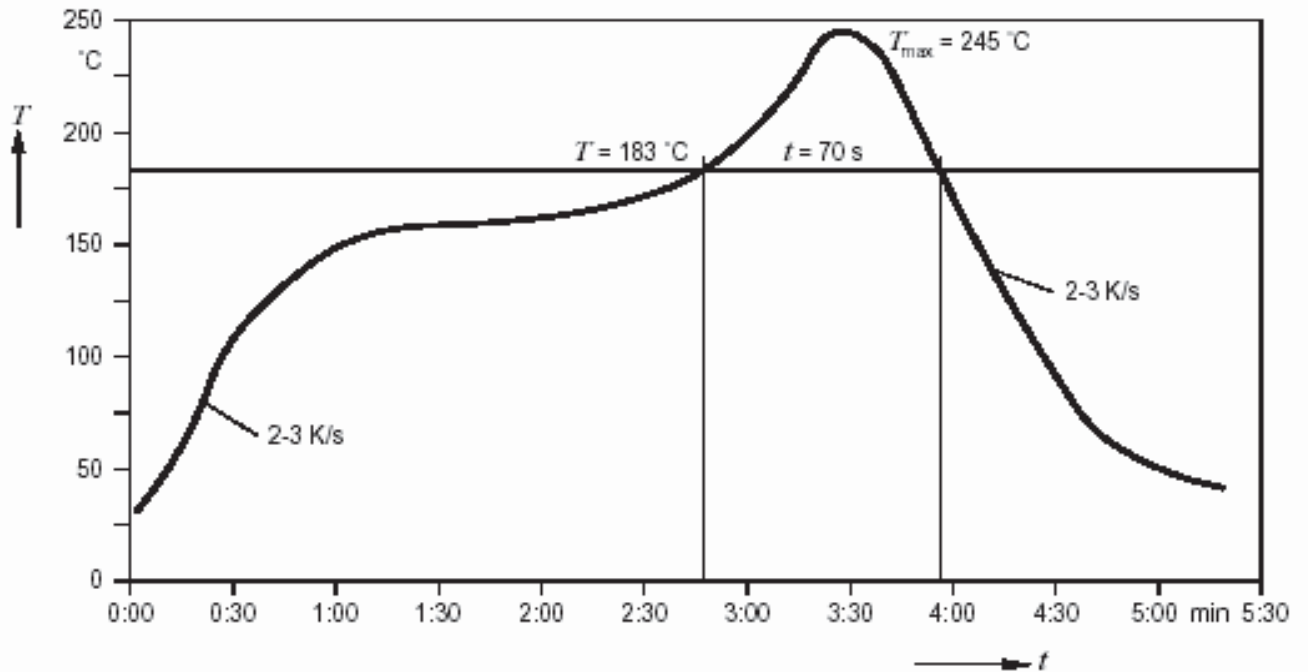
- \* If cleaning is required , use the following solutions for less than 1 minute and less than 40°C.
- \* Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- \* Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

● Suggest Soldering Pad Dimensions

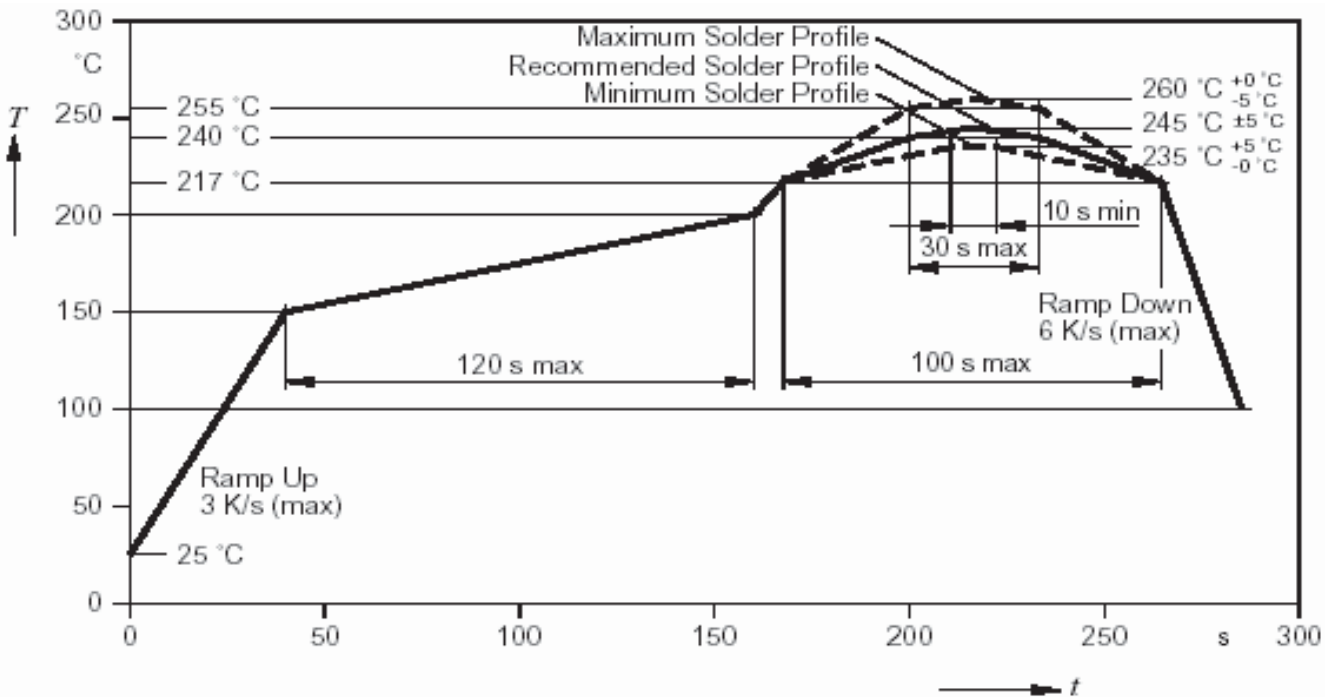


Direction of PWB camber  
and go to reflow furnace

● Suggest Sn/Pb IR Reflow Soldering Profile Condition:



● Suggest Pb-Free IR Reflow Soldering Profile Condition:





# SURFACE MOUNT DEVICE LED

Part No.: L-C195JYJGCT

REV:A / 0

## ● Bin Code List

Luminous Intensity (IV), Unit: mcd@20mA					
Yellow (a chip)			Green(b chip)		
Bin Code	Min	Max	Bin Code	Min	Max
N	28	45	L	11.2	18
P	45	71	M	18	28
Q	71	112	N	28	45
R	112	180	P	45	71

including 15% test tolerance

Dominant Wavelength (Hue), Unit: nm@20mA					
Yellow (a chip)			Green(b chip)		
Bin Code	Min	Max	Bin Code	Min	Max
YA	587	590	GA	567	570
YB	590	593	GB	570	573
YC	593	596	GC	573	576

Including  $\pm 1$ nm test tolerance

## CAUTIONS

### 1.Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

### 2.Storage:

Before opening the package:

The LEDs should be kept at 5°C to 30°C or less and 85%RH or less. The LEDs should be used within a year.

After opening the package:

The LEDs should be kept at 5°C to 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package.

Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time: 10 sec Max.

Soldering Iron: (Not recommended)

Temperature 300°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering:

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. performed consecutively cooling process is required between 1<sup>st</sup> and 2<sup>nd</sup> soldering processes.

4. Lead-Free Soldering

For Reflow Soldering:

- 1、Pre-Heat Temp:150-180°C,120sec.Max.
- 2、Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3、Peak Temperature:260°C、5sec.
- 4、Reflow Repetition:2 Times Max.
- 5、Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

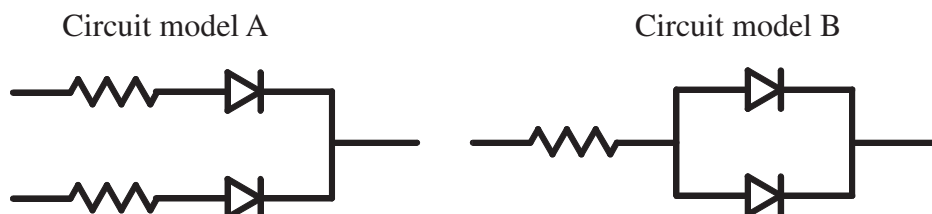
For Soldering Iron (Not Recommended):

- 1、Iron Tip Temp:350°C Max.
- 2、Soldering Iron:30w Max.
- 3、Soldering Time:3 Sec. Max. One Time.

For Dip Soldering:

- 1、Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2、Bath Temp:265°C Max.
- 3、Dip Time:5 Sec. Max.

5. Drive Method



(A)Recommended circuit.

(B)The difference of brightness between LED`s could be found due to the Vf-If characteristics of LED.



# SURFACE MOUNT DEVICE LED

Part No.: L-C195JYJGCT

REV:A / 0

## 6. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D: 1026 (1995) MIL-STD-883D: 1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C, RH= 90~95% *Test Time= 1000HRS±2HRS	MIL-STD-202F: 103B(1980) JIS C 7021: B-11 (1982)
	High Temperature Storage	Ta= 105±5°C Test Time= 1000HRS (-24HRS, 72HRS)	MIL-STD-883D: 1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS, 72H RS)	JIS C 7021:B-12 (1982)
Environmental Test	Temperature Cycling	105±5°C      -55±5°C 10mins      10mins      100 Cycles	MIL-STD-202F: 107D (1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1010 (1991) JIS C 7021: A-4 (1982)
	Thermal Shock	IR-Reflow In-Board, 2 Times 105±5°C      -55°C±5°C 10mins      10mins      100 Cycles	MIL-STD-202F: 107D(1980) MIL-STD-750D: 1051(1995) MIL-STD-883D: 1011(1991)
	Solder Resistance	Tsol= 260 ± 5°C Dwell Time= 10 ± 1sec	MIL-STD-202F: 210A(1980) MIL-STD-750D: 2031(1995) JIS C 7021: A-1 (1982)
	Solder ability	Tsol= 235 ± 5°C Immersion time 2±0.5 sec Immersion rate 25±2.5 mm/sec Coverage ≥95% of the dipped surface	MIL-STD-202F: 208D(1980) MIL-STD-750D: 2026(1995) MIL-STD-883D: 2003(1991) IEC 68 Part 2-20 JIS C 7021: A-2 (1982)

## 7. Others:

The appearance and specifications of the product may be modified for improvement without notice.